[117H7677]

	(Original Signature of Member)
118TH CONGRESS 1ST SESSION	H. R
To provide incentives f	the domestic production of printed circuit boards, and for other purposes.

IN THE HOUSE OF REPRESENTATIVES

Mr.	MOORE of Utah introduced	the	following	bill;	which	was	referred	to	the
	Committee on						_		

A BILL

To provide incentives for the domestic production of printed circuit boards, and for other purposes.

- 1 Be it enacted by the Senate and House of Representa-
- 2 tives of the United States of America in Congress assembled,
- 3 SECTION 1. SHORT TITLE.
- 4 This Act may be cited as the "Protecting Circuit
- 5 Boards and Substrates Act".

1	SEC. 2. TAX CREDIT FOR THE PURCHASE OR ACQUISITION
2	OF PRINTED CIRCUIT BOARDS MANUFAC-
3	TURED IN THE UNITED STATES.
4	(a) In General.—Subpart D of part IV of sub-
5	chapter A of chapter 1 of the Internal Revenue Code of
6	1986 is amended by inserting after section 45Z the fol-
7	lowing new section:
8	"SEC. 45AA. CREDIT FOR THE PURCHASE OR ACQUISITION
9	OF PRINTED CIRCUIT BOARDS FABRICATED
10	IN THE UNITED STATES.
11	"(a) In General.—For the purposes of section 38,
12	the credit determined under this section for the taxable
13	year is an amount equal to 25 percent of the cost paid
14	or incurred by the taxpayer for the purchase or acquisition
15	of printed circuit boards fabricated in the United States
16	for the taxable year.
17	"(b) Definitions.—For the purposes of this sec-
18	tion—
19	"(1) Printed circuit board.—The term
20	'printed circuit board' has the meaning given such
21	term in section 3(a) of the Protecting Circuit Boards
22	and Substrates Act.
23	"(2) Fabricated.—The term 'fabricated'
24	means the use of raw materials to manufacture a
25	connected composite structure featuring electrically

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conductive and non-conductive elements by subtrac-

2	tive, additive, or other technique.
3	"(c) REGULATIONS AND GUIDANCE.—The Secretary
4	shall, in consultation with the Secretary of Commerce,
5	promulgate such regulations and guidance as may be nec-
6	essary or appropriate to carry out this section.".
7	(b) Clerical Amendment.—The table of sections
8	for subpart D of part IV of subchapter A of chapter 1
9	of such Code is amended by inserting after the item relat-
10	ing to section 45Z the following new item:
	"Sec. 45AA. Credit for the purchase or acquisition of printed circuit boards fabricated in the United States.".
11	(e) Credit Made Part of General Business
12	CREDIT.—Section 38(b) of the Internal Revenue Code of
13	1986 is amended—
14	(1) in paragraph (37), by striking "plus",
15	(2) in paragraph (38), by striking the period at
16	the end and inserting ", plus", and
17	(3) by adding at the end the following new
18	paragraph:
19	"(39) the credit for the purchase or acquisition
20	of printed circuit boards fabricated in the United
21	States determined under section 45AA.".
22	(d) Effective Date.—The amendments made by
23	this section shall apply to amounts paid or incurred after
24	December 31, 2022.

1	SEC. 3. INCENTIVES FOR PRINTED CIRCUIT BOARD MANU-
2	FACTURING AND RESEARCH AND DEVELOP-
3	MENT.
4	(a) Definitions.—In this section:
5	(1) ACTIVE COMPONENT.—The term "active
6	component" means, with respect to a printed circuit
7	board, an electronic component within an electronic
8	circuit that relies on an external power source to
9	control or modify electrical signals.
10	(2) COVERED ENTITY.—The term "covered en-
11	tity" means a private entity, a consortium of private
12	entities, or a consortium of public and private enti-
13	ties with the ability to substantially finance, con-
14	struct, expand, or modernize a facility relating to
15	manufacturing or research and development of print-
16	ed circuit boards and integrated circuit substrates.
17	(3) COVERED INCENTIVE.—The term "covered
18	incentive" means—
19	(A) an incentive used for the purposes of
20	constructing, expanding, or modernizing a facil-
21	ity described in paragraph (2) that will be lo-
22	cated in the United States; and
23	(B) a workforce-related incentive (includ-
24	ing an agreement to provide grants for work-
25	force training or vocational education), any con-
26	cession with respect to real property, funding

1	for research and development with respect to
2	printed circuit boards, and any other incentive
3	determined by the Secretary, in consultation
4	with the Secretary of State, to be appropriate
5	and related to encouraging investment in facili-
6	ties and equipment in the United States for
7	manufacturing or research and development of
8	printed circuit boards.
9	(4) Economically disadvantaged indi-
10	VIDUAL.—The term "economically disadvantaged in-
11	dividual" means an individual described in section
12	8(a)(6)(A) of the Small Business Act (15 U.S.C.
13	637(a)(6)(A)).
14	(5) Foreign entity; foreign entity of
15	CONCERN.—The terms "foreign entity" and "foreign
16	entity of concern" have the meanings given such
17	terms in section 9901 of the William M. (Mac)
18	Thornberry National Defense Authorization Act for
19	Fiscal Year 2021 (Public Law 116–283; 15 U.S.C.
20	4651).
21	(6) HISTORICALLY BLACK COLLEGE OR UNI-
22	VERSITY.—The term "historically Black college or
23	university" has the meaning given the term "part B
24	institution" in section 322 of the Higher Education
25	Act of 1965 (20 U.S.C. 1061).

1	(7) Institution of higher education.—The
2	term "institution of higher education" has the
3	meaning given such term in section 101 of the High-
4	er Education Act of 1965 (20 U.S.C. 1001).
5	(8) Integrated circuit substrate.—The
6	term "integrated circuit substrate" means a thin
7	composite structure of layered electrically conductive
8	materials and organic electrically non-conductive ma-
9	terials that electrically connects integrated circuits
10	to an underlying structure, including a printed cir-
11	cuit board.
12	(9) Intelligence community.—The term
13	"intelligence community" has the meaning given
14	that term in section 3 of the National Security Act
15	of 1947 (50 U.S.C. 3003).
16	(10) Minority-owned business and women-
17	OWNED BUSINESS.—The terms "minority-owned
18	business" and "women-owned business" have the
19	meanings given such terms in section 704B(h) of the
20	Equal Credit Opportunity Act (15 U.S.C. 1691c-
21	2(h)).
22	(11) Minority-serving institution.—The
23	term "minority-serving institution" means any of
24	the following:

1	(A) An Alaska Native-serving institution
2	(as that term is defined in section 317(b) of the
3	Higher Education Act of 1965 (20 U.S.C.
4	1059d(b))).
5	(B) A Native Hawaiian-serving institution
6	(as that term is defined in section 317(b) of
7	such Act (20 U.S.C. 1059d(b))).
8	(C) A Predominantly Black institution (as
9	that term is defined in section 371(c) of such
10	Act $(20 \text{ U.S.C. } 1067q(e))).$
11	(D) An Asian American and Native Amer-
12	ican Pacific Islander-serving institution (as that
13	term is defined in section 320(b) of such Act
14	(20 U.S.C. 1059g(b))).
15	(E) A Native American-serving, nontribal
16	institution (as that term is defined in section
17	319(b) of such Act (20 U.S.C. 1059f(b))).
18	(12) Passive component.—The term "passive
19	component" means, with respect to a printed circuit
20	board, an electronic component within an electronic
21	circuit that functions using the existing electronic
22	current within the electronic circuit to control or
23	modify electrical signals.
24	(13) Person.—The term "person" means an
25	individual or entity.

1	(14) Printed Circuit Board.—The term
2	"printed circuit board" means a composite structure
3	of layered electrically conductive and non-conductive
4	materials that provides interconnections with other
5	micro-electronics or electronics systems or sub-
6	systems and electrical connections between active
7	and passive components, and may include compo-
8	nents embedded in the composite structure.
9	(15) Program.—The term "Program" means
10	the program established under subsection (b)(1).
11	(16) Secretary.—The term "Secretary"
12	means the Secretary of Commerce.
13	(17) Small business.—The term "small busi-
14	ness" has the meaning given the term "small busi-
15	ness concern" under section 3(a) of the Small Busi-
16	ness Act (15 U.S.C. 632(a)), except that section
17	121.103 of title 13, Code of Federal Regulations (or
18	any successor regulation) shall not apply.
19	(18) State.—The term "State" means each
20	State of the United States, the District of Columbia,
21	each commonwealth, territory, or possession of the
22	United States, and each federally recognized Indian
23	Tribe.
24	(19) Veteran-owned business.—The term
25	"veteran-owned business" has the meaning given the

1	term "small business concern owned and controlled
2	by veterans" in section 3(q) of the Small Business
3	Act (15 U.S.C. 632(q)).
4	(b) Financial Assistance Program.—
5	(1) IN GENERAL.—The Secretary shall establish
6	a program that, in accordance with the requirements
7	of this section and subject to the availability of ap-
8	propriations for such purposes, provides Federal fi-
9	nancial assistance to covered entities to incentivize
10	investment in facilities and equipment in the United
11	States for manufacturing or research and develop-
12	ment of printed circuit boards and integrated circuit
13	substrates.
14	(2) Procedure.—
15	(A) In general.—A covered entity shall
16	submit to the Secretary an application that de-
17	scribes the project for which the covered entity
18	is seeking financial assistance under the Pro-
19	gram.
20	(B) Eligibility.—Except as provided in
21	subparagraph (C), in order for a covered entity
22	to qualify for financial assistance under the
23	Program, the covered entity shall demonstrate
24	to the Secretary, in the application submitted

1	by the covered entity under subparagraph (A),
2	that—
3	(i) the covered entity has a docu-
4	mented interest in carrying out a project
5	that is a covered incentive; and
6	(ii) with respect to the project de-
7	scribed in clause (i), the covered entity
8	has—
9	(I) a plan the Secretary deter-
10	mines to be executable to sustain the
11	covered incentive described in clause
12	(i) without additional Federal finan-
13	cial assistance under the Program for
14	facility support;
15	(II) made commitments to work-
16	er and community investment, includ-
17	ing through—
18	(aa) training and education
19	benefits provided by or paid for
20	by the covered entity; and
21	(bb) programs to expand
22	employment opportunity for eco-
23	nomically disadvantaged individ-
24	uals; and

1	(III) secured commitments from
2	regional educational and training enti-
3	ties, postsecondary vocational institu-
4	tions (defined in section 102(c) of the
5	Higher Education Act of 1965 (20
6	U.S.C. 1002(c))), or institutions of
7	higher education to provide workforce
8	training, including programming for
9	training and job placement of eco-
10	nomically disadvantaged individuals.
11	(C) SMALL BUSINESS EXCEPTION.—The
12	requirements in subclauses (II) and (III) of
13	subparagraph (B)(ii) do not apply to small
14	businesses.
15	(D) DUE DILIGENCE.—With respect to the
16	review by the Secretary of an application sub-
17	mitted by a covered entity under subparagraph
18	(A), the Secretary may not approve the applica-
19	tion unless the Secretary—
20	(i) confirms that the covered entity
21	has satisfied the applicable eligibility cri-
22	teria under subparagraph (B); and
23	(ii) determines that the project to
24	which the application relates is in the in-
25	terest of the United States.

1	(E) Considerations for review.——
2	(i) In general.—Except as provided
3	in clause (ii), with respect to the review by
4	the Secretary of an application submitted
5	by a covered entity under subparagraph
6	(A), the Secretary shall consider whether
7	the covered entity has—
8	(I) previously received financial
9	assistance under the Program; and
10	(II) demonstrated that it is re-
11	sponsive to the national security needs
12	or requirements established by the in-
13	telligence community (or an agency
14	thereof), the National Nuclear Secu-
15	rity Administration, or the Depart-
16	ment of Defense.
17	(ii) Small businesses excluded.—
18	Clause (i)(I) does not apply with respect to
19	an application submitted by a small busi-
20	ness under subparagraph (A).
21	(F) Preferences.—
22	(i) In General.—The Secretary
23	shall, when practicable, give preference
24	with respect to the approval of an applica-

1	tion submitted under subparagraph (A) by
2	a covered entity that—
3	(I) is a small business, minority-
4	owned business, women-owned busi-
5	ness, or veteran-owned business;
6	(II) expands the United States
7	production capacity of integrated cir-
8	cuit substrates;
9	(III) is relocating a manufac-
10	turing facility of printed circuit
11	boards currently located in an area
12	owned by, controlled by, or subject to
13	the jurisdiction or direction of a for-
14	eign entity of concern; or
15	(IV) includes a workforce train-
16	ing program that is—
17	(aa) a historically Black col-
18	lege or university;
19	(bb) a Hispanic-serving in-
20	stitution (as such term is defined
21	in section 502(a) of the Higher
22	Education Act of 1965 (20
23	U.S.C. 1101a(a)));
24	(ce) a Tribal College or Uni-
25	versity (as such term is defined

1	in section 316(b) of the Higher
2	Education Act of 1965 (20
3	U.S.C. 1059e(b)));
4	(dd) a minority-serving in-
5	stitution;
6	(ee) a rural-serving institu-
7	tion of higher education (as such
8	term is defined in section 861(b)
9	of the Higher Education Act of
10	1965 (20 U.S.C. 1161q(b))); or
11	(ff) a workforce training or-
12	ganization that offers industry-
13	recognized, stackable, and port-
14	able credentialing programs.
15	(ii) Definitions.—In this subpara-
16	graph:
17	(I) STACKABLE.—The term
18	"stackable" means a credential that is
19	part of a set of sequenced, related cre-
20	dentials that demonstrating the in-
21	creasing qualifications of the indi-
22	vidual acquiring the credentials for
23	advancement along a specific career
24	path or to a more senior position in
25	the same or related career path.

1	(II) PORTABLE.—The term
2	"portable" means a credential that is
3	generally recognized and accepted by
4	a wide variety of entities and in mul-
5	tiple geographic locations as verifying
6	the qualifications of an individual.
7	(G) Foreign entities of concern ex-
8	CLUSION.—
9	(i) The Secretary may not approve an
10	application of a covered entity if the Sec-
11	retary determines that the covered entity is
12	a foreign entity of concern.
13	(ii) None of the funds authorized to
14	be appropriated to carry out this sub-
15	section may be provided to a foreign entity
16	of concern.
17	(H) RECORDS PRODUCTION.—
18	(i) IN GENERAL.—The Secretary may
19	request from a covered entity that submits
20	an application under subparagraph (A) any
21	records and other information that the
22	Secretary determines necessary for the
23	purposes of ascertaining whether an award
24	under the Program will be used for the
25	covered incentive for which such award is

1	sought, including records or other informa-
2	tion regarding the status of such project.
3	(ii) Funding restriction.—No cov-
4	ered entity that fails to provide records or
5	information requested by the Secretary
6	under this subparagraph shall be eligible
7	for Federal financial assistance under the
8	Program if such records or information are
9	reasonably available to such covered entity.
10	(3) Amount.—
11	(A) IN GENERAL.—The Secretary shall de-
12	termine the appropriate amount and funding
13	type for each financial assistance award made
14	to a covered entity under the Program.
15	(B) Larger investment.—The amount
16	awarded under the Program with respect to any
17	individual project may not exceed \$300,000,000
18	unless the Secretary, in consultation with the
19	Secretary of Defense and the Director of Na-
20	tional Intelligence, recommends to the Presi-
21	dent, and the President notifies Congress, that
22	a larger award is necessary to—
23	(i) significantly increase the supply of
24	reliable, domestically produced printed cir-
25	cuit boards that are relevant for the na-

1	tional security and economic competitive-
2	ness of the United States; and
3	(ii) meet the needs of national secu-
4	rity.
5	(4) Use of funds.—
6	(A) In general.—Except as provided by
7	subparagraph (B), a covered entity that re-
8	ceives a financial assistance award under the
9	Program may only use the financial assistance
10	award amounts—
11	(i) for a covered incentive; and
12	(ii) to pay reasonable costs related to
13	the operating expenses for such covered in-
14	centive, including costs relating to the spe-
15	cialized workforce, essential materials, and
16	complex equipment maintenance, as deter-
17	mined by the Secretary.
18	(B) LARGER INVESTMENTS.—If the
19	amount awarded under the Program with re-
20	spect to the project is more than \$300,000,000,
21	the covered entity that received such award may
22	use such amounts only for the purposes de-
23	scribed in subparagraph (A) to the extent that
24	such use meets the national security needs or

1	enhances the economic competitiveness of the
2	United States.
3	(5) Clawback.—
4	(A) DELAY CLAWBACK.—
5	(i) Target dates.—With respect to
6	any award made under the Program, the
7	Secretary shall—
8	(I) determine target dates by
9	which the project with respect to
10	which such award was made shall
11	commence and complete; and
12	(II) set such dates by the time of
13	the award.
14	(ii) Progressive recovery for
15	DELAYS.—If a project is not commenced
16	and completed by the dates determined
17	under clause (i) for such project, the Sec-
18	retary shall progressively recover from the
19	recipient of the award for such project up
20	to the full amount of such award.
21	(iii) Waiver.—In the case of a
22	project that is not commenced or com-
23	pleted by the dates determined under
24	clause (i) for such project, the Secretary
25	may waive elements of the clawback provi-

1	sions incorporated in the award made
2	under the Program for such project only if,
3	prior to granting such waiver, the Sec-
4	retary—
5	(I) makes a formal determination
6	that circumstances beyond the ability
7	of the covered entity to foresee or con-
8	trol are responsible for delays; and
9	(II) submits a notice to Congress.
10	(B) TECHNOLOGY CLAWBACK.—The Sec-
11	retary may recover the full amount of any
12	award made under the Program from the re-
13	cipient of the award if, during the period deter-
14	mined under subparagraph (A)(i) for the
15	project with respect to which such award was
16	made, the recipient knowingly engages in any
17	joint research or technology licensing effort
18	with a foreign entity of concern that relates to
19	a technology or product that raises national se-
20	curity concerns, as determined by the Secretary.
21	(C) Notification to congress.—
22	(i) IN GENERAL.—The Secretary shall
23	notify Congress of—

1	(I) the clawback provisions at-
2	tending each award described in sub-
3	paragraph (A)(i); and
4	(II) each waiver provided under
5	subparagraph (A)(iii) not later than
6	15 days after the date on which the
7	Secretary provides such waiver.
8	(ii) Waiver notice contents.—The
9	notice required under clause (i)(II) shall
10	include—
11	(I) the elements of the clawback
12	provisions that were waived under
13	subparagraph (A)(iii);
14	(II) an explanation of why such
15	waiver was provided;
16	(III) the duration of the delay
17	with respect to which such waiver was
18	granted; and
19	(IV) the name of the covered en-
20	tity that was granted such waiver.
21	(c) Coordination Required.—In carrying out the
22	Program, the Secretary shall coordinate with—
23	(1) the Secretary of State;
24	(2) the Secretary of Defense;
25	(3) the Secretary of Energy;

1	(4) the Director of National Intelligence;
2	(5) the Director of the Minority Business De-
3	velopment Agency of the Department of Commerce;
4	(6) the Administrator of the Small Business
5	Administration;
6	(7) the Director of the National Institute of
7	Standards and Technology;
8	(8) the Director of the Cybersecurity and Infra-
9	structure Agency; and
10	(9) the Director of the Office of Foreign Assets
11	Control of the Department of the Treasury.
12	(d) GAO REVIEWS.—The Comptroller General of the
13	United States shall—
14	(1) not later than 2 years after the date of dis-
15	bursement of the first award under the Program,
16	and biennially thereafter for 10 years, conduct a re-
17	view of the Program, which shall include—
18	(A) a determination of the number of
19	awards provided under the Program during the
20	two-year period immediately preceding the re-
21	view;
22	(B) an evaluation of how—
23	(i) such program is being carried out,
24	including how recipients of awards under
25	the Program are being selected; and

1	(ii) other Federal programs are lever-
2	aged for manufacturing, research, and
3	training to complement the awards made
4	under the Program; and
5	(C) a description of the outcomes of
6	projects supported by awards made under the
7	Program, including a description of—
8	(i) facilities described in subsection
9	(b)(1) that were constructed, expanded, or
10	modernized as a result of such awards;
11	(ii) research and development carried
12	out with such awards;
13	(iii) workforce training programs car-
14	ried out with such awards, including ef-
15	forts to hire economically disadvantaged
16	individuals; and
17	(iv) the effects of such projects on the
18	United States share of global printed cir-
19	cuit board production; and
20	(2) notify Congress of the results of each review
21	conducted under paragraph (1).
22	(e) Authorization of Appropriations.—There is
23	authorized to be appropriated \$3,000,000,000 for fiscal
24	year 2024, to remain available through fiscal year 2025,
25	to carry out this section.